

4.5x2mm SMD CHIP LED LAMP





PRELIMINARY SPEC

Features

- 4.5x2mm SMT LED,2.8mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- \bullet Package : 1000pcs/reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

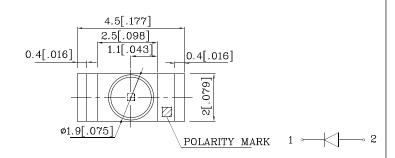


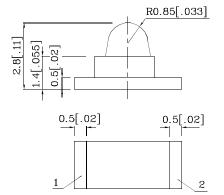


Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.2(0.008") unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Rating (TA=25°C)	M2ACY (AlInGaP)	Unit	
Reverse Voltage	VR	5	V
Forward Current	IF	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA
Power Dissipation	Рт	75	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	





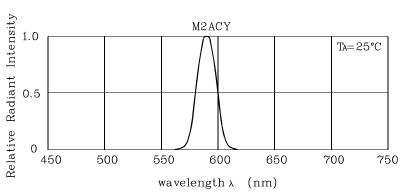
Operating Characteristic (TA=25°C)	M2ACY (AlInGaP)	Unit	
Forward Voltage (Typ.) (IF=20mA)	VF	2.0	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength of Peak Emission (Typ.) (IF=20mA)	λΡ	590	nm
Wavelength of Dominant Emission (Typ.) (IF=20mA)	λ D	589	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	20	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Inter (IF=2	inous nsity (0mA) cd	$\begin{array}{c} Wave length \\ nm \\ \lambda \ P \end{array}$	Viewing Angle 2 0 1/2
				min.	typ.		
XZM2ACY77W	Yellow	AlInGaP	Water Clear	1500	2990	590	20°
Published Date :	JAN 12.2009	Drawin	2 No : XDSB2803	V1	Check	ed : B.L.LIU	P.1/4



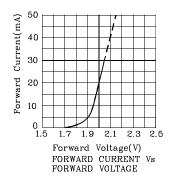
Part Number: XZM2ACY77W

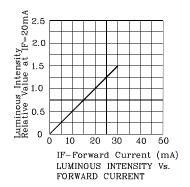
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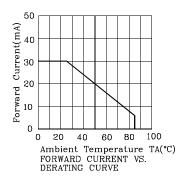


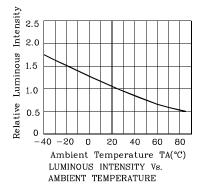
RELATIVE INTENSITY Vs. WAVELENGTH

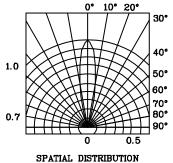
❖ M2ACY









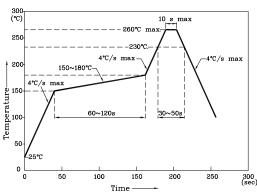


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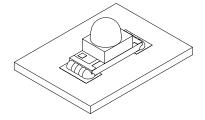
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

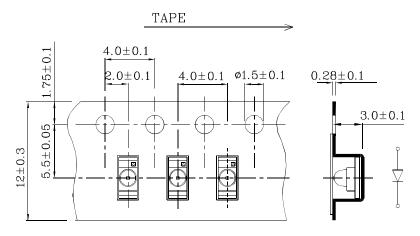


NOTES:

- Maximum soldering temperature should not exceed 260°c.
- 2. Recommended reflow temperature: 145°c-260°c.
- Do not put stress to the epoxy resin during high temperatures conditions.
- **♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)
 - 1.4 1.4 1.4 7 8 1.4
- ❖ The device has a single mounting surface. The device must be mounted according to the specifications.



* Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

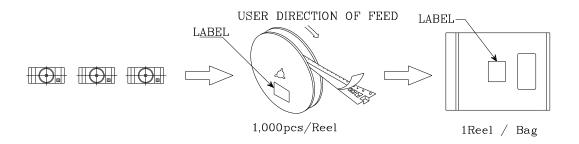
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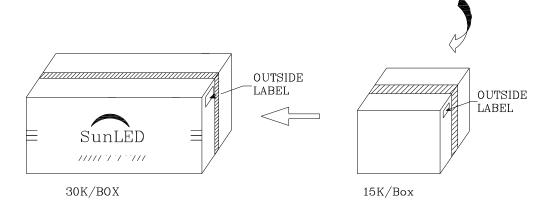


Part Number: XZM2ACY77W 4.5x2mm SMD CHIP LED LAMP

PACKING & LABEL SPECIFICATIONS

XZM2ACY77W







QTY: 1,000 pcs CODE: XXX

S/N: XX

LOT NO:



RoHS Compliant